

# HSF

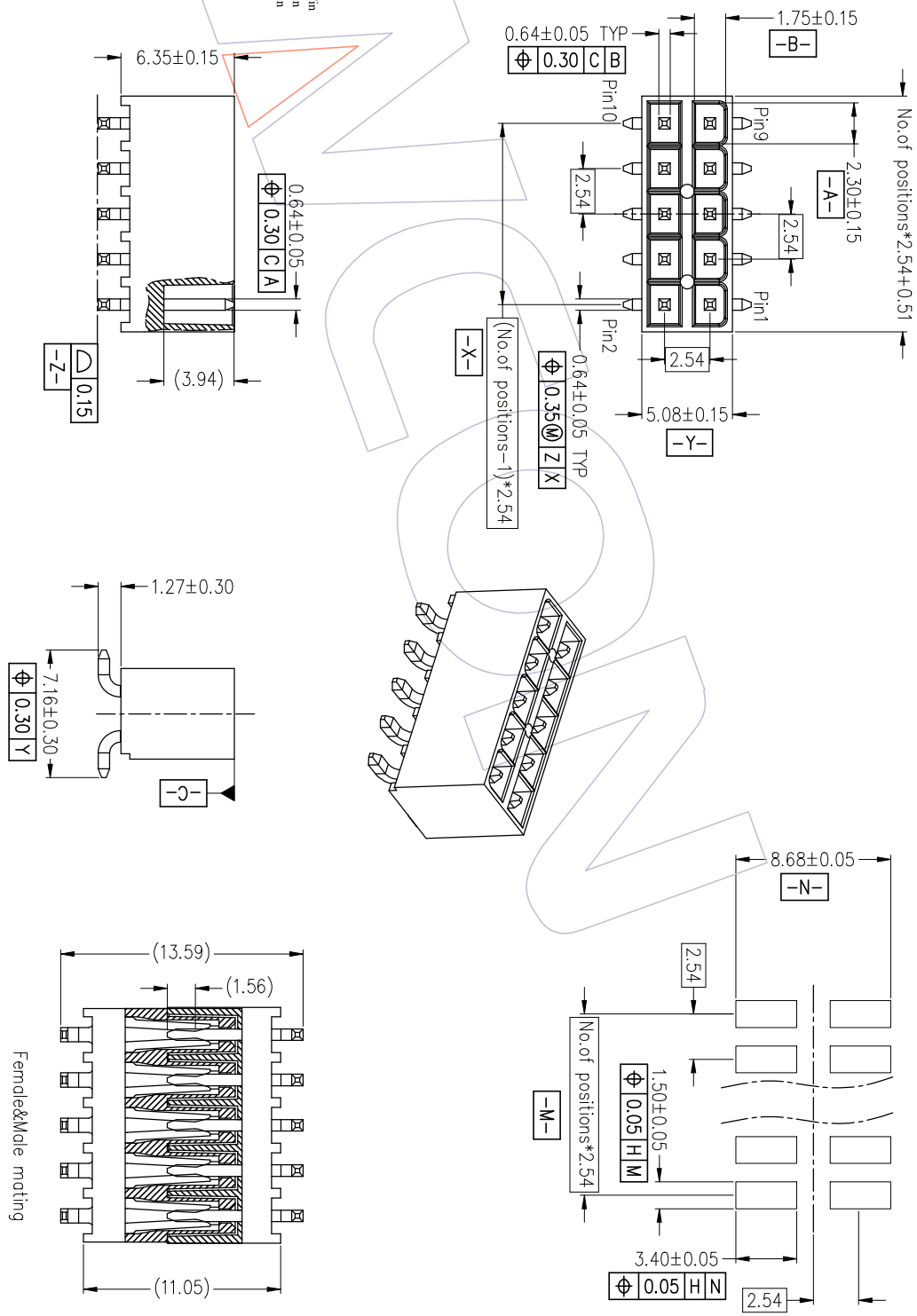
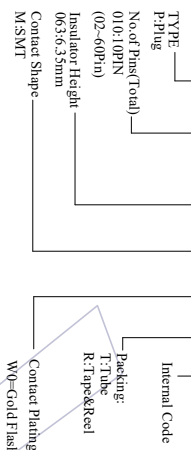
**NOTES:**

- Current Rating: 3.0AMP
- Voltage Rating: 250V
- Contact Resistance: 20mΩ Max
- Withstand Voltage: 775V AC
- Insulation Resistance: 1000MΩ Min
- Operation Temperature: -55℃ to +105℃
- Contact Material: Copper alloy
- Contact plating:

Xu"Glod on contact ared(See ordering information).  
 100u"Matte-Tin on solder area.  
 50u"Nickel underplating overall.  
 Insulator Material: LCP UL94V-0(Sld)  
 IR soldering: Peak temperature: 260±5℃, 5s

## Ordering Information

3600 - P XXX - 063 M XX X 01



Recommended P.C.B layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05 )



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE:	<b>WCON</b> Http: www.wcon.com WCON-Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com	WCON-Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: sales@wcon.com
A0	2020/05/12	NEW	-----	XX	Bruce	2020/05/12	mm	A4	3600-P-XXX-063MXXX01	2.54mm Board to Board Conn., "S" Type, Plug, SMT, H=6.35mm		
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE:		
				XX								
				X.XX	CHECK	DATE	UNIT					
				X.XXX	±0.35		mm					
				Angle	APPROVE	DATE	SIZE					
				± 3'			A4					
				DIM		DATE	1/2					
				TOL		DATE	PROJ.					